



PCN Number: MC041817 Chgnot.doc rev 13 1/14

Product/Process Change Notification (PCN)

Customer: Digi-Key	Date: 4/18/2017
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Customer Part # and/or Lot# affected: A6264KLYTR-T

Originator: M	ork Coggiono	Phono:	508-854-5603
Originator: M	ark Caggiano	Phone:	300-034-3003

Duration of Change:	Permanent X Temporary (explain)
Summary description of change: Part Cha	nge: Process Change: χ Other:

- 1. Allegro currently manufactures the A6264KLYTR-T at wafer fab, Polar Semiconductor LLC. (PSL), Bloomington, MN, USA using ABCD5-8 technology. We will add a second source wafer fab known as United Microelectronics Corporation (UMC), Hsinshu, Taiwan using ABCD5-8 technology.
- 2. The above listed device will have an additional final test location: Allegro MicroSystems (Thailand) Co., Ltd. (AMTC).

What is the part or process changing from (provide details)?

- 1. Allegro currently manufactures the A6264KLYTR-T at wafer fab, Polar Semiconductor LLC. (PSL), Bloomington, MN, USA using ABCD5-8 technology.
- 2. In addition to the current Allegro MicroSystems Philippines, Inc. (AMPI) test facility location, located in Manila, Philippines, a second test facility referred to as Allegro MicroSystems (Thailand) Co., Ltd. (AMTC) located in Saraburi, Thailand will be added as a primary site.

What is the part or process changing to (describe the anticipated impact of this change on form, fit and/or function)?

- 1. The A6264KLYTR-T will have a second source wafer fab known as United Microelectronics Corporation (UMC), Hsinshu, Taiwan using ABCD5-8 technology.
- 2. Allegro will be expanding its manufacturing capabilities with the addition of a new, whollyowned integrated circuit test facility located in Saraburi, Thailand. The same make and model test equipment will be utilized and test site transfer buy off data will be on file for each device before production begins.

Note: Validation of equivalence within a specific application is at the discretion of the Customer







Reliability Qualification Results

<u>Device:</u> 6264 (9264) <u>Assy Lot #:</u> 1545860UAAA <u>Number of Leads:</u> 10 <u>Fab Location:</u> UMC Package: LY (MSOP)
Assembly Location: Unisem
Lead Finish: 100% Sn
Tracking Number: 3270

Reason for Qualification: 6264 (9264) -LED Array Driver

Reliability Qualification Results						
6264, (9264) STR#32	70			Requiremen		Requirements
Stress Test	Abv.	Test #	Test Method	Test Conditions	s.s.	Results
Preconditioning	PC	A1	JESD22-A113 / J-STD-020	85°C/60% RH, 168 hrs, Peak Reflow=260°C; MSL2, (HAST, AC, TC)	231	0 Rejects
HAST	HAST	A2	JESD22-A110	Ta=130°C, 2 ATM, 85% RH, 0, 96 hrs	77	0 Rejects
Autoclave	AC	А3	JESD22-A102	Ta=121°C, 100% RH, 15 psig, 0, 96 hrs	77	0 Rejects
Temperature Cycle	TC	A4	JESD22-A104	Ta = -65°C to +175°C, 0, 500, 1000 Cycles	77	0 Rejects
High Temperature Storage Life	HTSL	A6	JESD22-A103	Ta = 175°C, 0, 1000 hrs	77	0 Rejects
High Temperature Operating Life	HTOL	B1	JESD22-A108	Ta = 150°C, 0, 1000 hrs	77	0 Rejects
Early Life Failure Rate	ELFR	B2	AEC-Q100-008 / JESD22-A108	Ta = 150°C, 0, 48 hrs	800	0 Rejects
Wire Bond Pull	WBP	C2	Mil-Std-883 Method 2011	Temp conditions and sample size are defined in the test method. (after TC)		0 Rejects; Ppk>1.67
Solderability	SD	C3	JESD22-B102	Meniscograph	10	0 rejects; > 95% Lead Coverage
Electrostatic Discharge Human Body Model	нвм	E2	AEC-Q100-002 / JS-001-2014	Test Conditions, Sampling Size are do in the Test Method	efined	Classification 2, HBM =2.5 kV
Electrostatic Discharge Charged Device Model	CDM	E3	AEC-Q100-011	Test Conditions, Sampling Size are defined in the Test Method		Classification = C6, > 1kV
Latch-Up	Ш	F4	JESD78	Test Conditions, Sampling Size are de	efined	Class II, Level B
Electrical Distribu	(Θ	80.2%	· 🕒 🗮 🔁 💽		0 Rejects; Cpk>1.67

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Is a PPAP update required?	Yes No X			
Is reliability testing required? (If Yes, refer to attached plan)	Yes X No (explain)			





Expected PPAP availability date: Available Upon Request

Target implementation date: October 2017		
Estimated date of first shipment: November 2017		
Expected sample availability date: Available Upon Request		
Yes		Date Required:
Customer Approval Required: No	Х	Notification Only
Please note: It is our intention to inform our customer of changes as early as possible. Under Allegro's procedure for product/process change notification, Allegro strives, based on its technical judgment, to provide notification of significant changes that may affect form, fit or function. However, as Allegro cannot ensure evaluation of product/process changes for each and every application; the customer retains responsibility to validate the impact of a change on its application suitability. If samples are needed for validation of a change, requests may be made via the contact information provided herein. Please contact your Account Manager or local Sales contact for any questions. We would kindly request your consideration so we can meet our target date for implementation. Unless both parties agree to extend the implementation date, this change will be implemented as scheduled.		
Customer comments/Conditions of Acceptance:		
Approved by: cc: Allegro Sales/Marketing/Quality	Date:	Title: